



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of) Examiner: F. Palo
Shih-Pan-Yu Hsieh) Group Unit: 3644
Serial No.: 09/885,140) Response to Paper No.: 2
Filed: June 20, 2001)
For: SEED SOWING METHOD &)
MATERIALS)

Assistant Commissioner for Patents
Washington, D.C. 20231

SIR:

**AMENDMENT AND REQUEST FOR RECONSIDERATION
UNDER 37 C.F.R. §1.111**

In Response to the Official Action dated August 28, 2002,
please amend the above-identified patent application as
follows:

In the Claims:

1. (Amended) A method of sowing plant seeds, comprising
the steps of:

a) providing a thin base with water-absorbing
ability, humidity-maintaining ability, and natural decomposing
ability, wherein said thin base comprises a plurality of
concavities;

b) inlaying said plant seeds in said plurality of
concavities of said thin base and covering said plant seeds
with a securing layer; and

c) covering a cultivating material with said thin
base, wherein each concavity has a void therein for allowing a
radicle of a corresponding plant seed to pierce therethrough

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